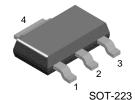


BCP51

PNP General Purpose Amplifier

- This device is designed for general purpose medium power amplifiers and switches requiring collecor currents to 1.0A.
- Sourced from process 77.



1. Base 2. Collector 3. Emitter

Absolute Maximum Ratings* T_a=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	-45	V
V _{CBO}	Collector-Base Voltage	-45	V
V _{EBO}	Emitter-Base Voltage	-5.0	V
I _C	Collector Current - Continuous	-1.5	Α
T _J , T _{STG}	Operating and Storage Junction Temperature Range	- 55 ~ 150	°C

^{*} These ratings are limiting values above whitch the serviceability of any semiconductor device may be impaird.

- NOTES:
 1. These ratings are based on a maximum junction temperature of 150 degrees C.
 2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics T_a=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units	
Off Characteristics						
V _{(BR)CEO}	Collector-Emitter Sustaining Voltage	$I_C = -10 \text{mA}, I_B = 0$	-45		V	
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = -100\mu A, I_E = 0$	-45		V	
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = -10\mu A, I_C = 0$	-5.0		V	
I _{CBO}	Collector Cutoff Current	$V_{CB} = -30V, I_{E} = 0$ $V_{CB} = -30V, I_{E} = 0, T_{a} = 125^{\circ}C$		-100 -10	nA μA	
I _{EBO}	Emitter Cut-off Current	$V_{EB} = -5.0V, I_{C} = 0$		-10	μΑ	
On Characteristics						
h _{FE}	DC Current Gain	$I_C = -5.0$ mA, $V_{CE} = -2.0$ V $I_C = -150$ mA, $V_{CE} = -2.0$ $I_C = -500$ mA, $V_{CE} = -2.0$ V	25 40 25	250		
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C = -500mA, I _B = -50mA		-0.5	V	
V _{BE} (on)	Base-Emitter On Voltage	I _C = -500mA, V _{CE} = -2.0V		-1.0	V	

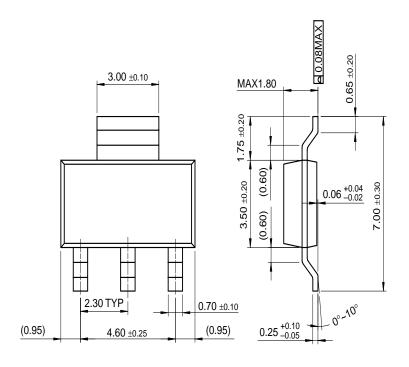
Thermal Characteristics T_a=25°C unless otherwise noted

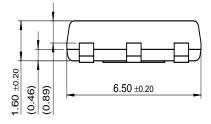
Symbol	Parameter	Max.	Units
P_{D}	Total Device Dissipation	1.0	W
	Derate above 25°C	8.0	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	125	°C/W

^{*} Device mounted on FR-4PCB 36mm x 18mm x 1.5mm; mounting pad for the collector lead min. 6cm².

Package Dimensions

SOT-223





Dimensions in Millimeters

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